

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yves Morand	01/17/2013
Perrine Batude	01/17/2013
RECEIVING PARTY DATA	
Name:	STMicroelectronics S.A.
Street Address:	29, Boulevard Romain Rolland
City:	Montrouge
State/Country:	FRANCE
Postal Code:	92120
Name:	Commissariat a l'Energie Atomique et aux Energies Alternatives
Street Address:	Batiment Le Ponant D, 25 Rue Leblanc
City:	Paris
State/Country:	FRANCE
Postal Code:	75015
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13748126
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	617-646-8000
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Correspondent Name:	James H. Morris
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OP \$40.00 13748126

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PATENT
REEL: 029692 FRAME: 0092

ATTORNEY DOCKET NUMBER:	S1022.71728US00
NAME OF SUBMITTER:	Gail Driscoll
Total Attachments: 4 source=S102271728US00 Assignment as filed#page1.tif source=S102271728US00 Assignment as filed#page2.tif source=S102271728US00 Assignment as filed#page3.tif source=S102271728US00 Assignment as filed#page4.tif	


ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned Assignor, hereby:

1. Sell, assign and transfer to STMicroelectronics S.A., having a place of business at 29, Boulevard Romain Rolland, 92120 Montrouge, FRANCE, its successors, assigns and legal representatives, all hereinafter referred to as the Assignee, my entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and designs which are disclosed in the application for United States Letters Patent, bearing Attorney Docket No. S1022.71728US00, and entitled METHOD FOR FORMING A VIA CONTACTING SEVERAL LEVELS OF SEMICONDUCTOR LAYERS, and in and to the application and all corresponding provisional, non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent, utility models, industrial designs or similar intellectual property rights which have been or shall be filed in the United States, internationally, and in any foreign country, including but not limited to China, Japan and Korea, on any of the inventions; and in and to all original and reissued patents which have been or shall be issued in the United States or any other jurisdiction on the inventions, including the right to apply for patent rights in each foreign country and all rights to priority, including the right to claim priority for China, Japan and Korea;
2. Agree that the Assignee may apply for and receive Letters Patent and utility model and industrial design registrations for the inventions in its own name; and when requested, without charge to but at the expense of the Assignee, I agree to carry out in good faith the intent and purpose of this assignment, by executing all non-provisional, divisional, continuing, substitute, renewal, reissue, and all other patent, utility model and industrial design applications on any and all the inventions, by executing all rightful oaths, assignments, powers of attorney and other papers, by communicating to the Assignee all facts known to me relating to the inventions and the history thereof, and generally by doing everything reasonably possible which the Assignee shall consider desirable for aiding in securing and maintaining proper protection for the inventions and for vesting title to the inventions and all applications for patents and all patents on the inventions, in the Assignee;
3. Request the Director of the United States Patent and Trademark Office to issue the Letters Patent to the Assignee;
4. Authorize and request Wolf, Greenfield & Sacks, P.C. to supply any missing patent/application identification information or correct any errors in the patent/application identification information provided above, whether discovered prior to or after recordation; Covenant with the Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me; and
5. Appoint Assignee, through its designee, my attorney-in-fact to execute, in my name and on my behalf, any and all documents required to effectuate this Assignment, specifically including, but not limited to, those documents specified above and any necessary corrective assignments.

This instrument is signed under the pains and penalties of perjury under the laws of the United States of America.

Date: 17/01/2013 Signature:


Yves Morand

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned Assignor, hereby:

1. Sell, assign and transfer to Commissariat à l'Énergie Atomique et aux Énergies Alternatives, having a place of business at Bâtiment Le Ponant D, 25 Rue Leblanc, 75015 Paris, FRANCE, its successors, assigns and legal representatives, all hereinafter referred to as the Assignee, my entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and designs which are disclosed in the application for United States Letters Patent, bearing Attorney Docket No. S1022.71728US00, and entitled METHOD FOR FORMING A VIA CONTACTING SEVERAL LEVELS OF SEMICONDUCTOR LAYERS, and in and to the application and all corresponding provisional, non-provisional, divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent, utility models, industrial designs or similar intellectual property rights which have been or shall be filed in the United States, internationally, and in any foreign country, including but not limited to China, Japan and Korea, on any of the inventions; and in and to all original and reissued patents which have been or shall be issued in the United States or any other jurisdiction on the inventions, including the right to apply for patent rights in each foreign country and all rights to priority, including the right to claim priority for China, Japan and Korea;

2. Agree that the Assignee may apply for and receive Letters Patent and utility model and industrial design registrations for the inventions in its own name; and when requested, without charge to but at the expense of the Assignee, I agree to carry out in good faith the intent and purpose of this assignment, by executing all non-provisional, divisional, continuing, substitute, renewal, reissue, and all other patent, utility model and industrial design applications on any and all the inventions, by executing all rightful oaths, assignments, powers of attorney and other papers, by communicating to the Assignee all facts known to me relating to the inventions and the history thereof, and generally by doing everything reasonably possible which the Assignee shall consider desirable for aiding in securing and maintaining proper protection for the inventions and for vesting title to the inventions and all applications for patents and all patents on the inventions, in the Assignee;

3. Request the Director of the United States Patent and Trademark Office to issue the Letters Patent to the Assignee;

4. Authorize and request Wolf, Greenfield & Sacks, P.C. to supply any missing patent/application identification information or correct any errors in the patent/application identification information provided above, whether discovered prior to or after recordation; Covenant with the Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me; and

5. Appoint Assignee, through its designee, my attorney-in-fact to execute, in my name and on my behalf, any and all documents required to effectuate this Assignment, specifically including, but not limited to, those documents specified above and any necessary corrective assignments.

This instrument is signed under the pains and penalties of perjury under the laws of the United States of America.

Date:

12/01/13

Signature:

P. Batude
Perline Batude